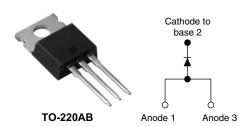


High Performance Schottky Generation 5.0, 20 A



PRODUCT SUMMARY				
I _{F(AV)}	20 A			
V_{R}	100 V			
V _F at 20 A at 125 °C	0.68 V			

FEATURES

- 175 °C high performance Schottky diode
- Very low forward voltage drop
- Extremely low reverse leakage
- Optimized V_F vs. I_R trade off for high efficiency
- Increased ruggedness for reverse avalanche capability
- RBSOA available
- Negligible switching losses
- Submicron trench technology
- Full lead (Pb)-free and RoHS compliant devices
- Designed and qualified for industrial level

APPLICATIONS

- High efficiency SMPS
- · Automotive
- · High frequency switching
- · Output rectification
- · Reverse battery protection
- · Freewheeling
- · Dc-to-dc systems
- · Increased power density systems

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL CHARACTERISTICS VALUES UNITS							
V _{RRM}		100	V				
V _F	20 Apk, T _J = 125 °C (typical, per leg)	0.65	V				
T _J	Range	- 55 to 175	°C				

VOLTAGE RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	21TT100	UNITS
Maximum DC reverse voltage	V_R	T _J = 25 °C	100	V

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDIT	IONS	VALUES	UNITS	
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T_C = 142 °C, rec	tangular waveform	20		
Maximum peak one cycle	_	5 μs sine or 3 μs rect. pulse	Following any rated	660	Α	
non-repetitive surge current at T _J = 175 °C	I _{FSM}	10 ms sine or 6 ms rect. pulse	load condition and with rated V _{RRM} applied	220		
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}$, $I_{AS} = 1.5 \text{A}$, $L = 60 \text{mH}$		67.5	mJ	
Repetitive avalanche current	I _{AR}	Limited by frequency of operation and time pulse duration so that $T_J < T_J$ max. I_{AS} at T_J max. as a function of time pulse See fig. 8		I _{AS} at T _J max.	А	

High Performance Schottky Generation 5.0, 20 A



ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITION	TYP.	MAX.	UNITS		
		20 A	T.ı = 25 °C	-	0.80		
Forward voltage drap	V _{FM} ⁽¹⁾	40 A	1J=25 C	-	0.95	V	
Forward voltage drop	VFM (1)	20 A	T _{.I} = 125 °C	-	0.68		
		40 A	1j = 125 C	-	0.82		
Payerea laakaga aurrent	I _{RM} ⁽¹⁾	T _J = 25 °C	V Doted V	-	150	μΑ	
Reverse leakage current		T _J = 125 °C	V_R = Rated V_R	-	6	mA	
Junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		850	-	pF	
Series inductance	L _S	Measured lead to lead 5 mm from package body		8.0	-	nΗ	
Maximum voltage rate of change	dV/dt	Rated V _R	-	10 000	V/μs		

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	ETER SYMBOL TEST CONDITIONS VALUES UNI					
Maximum junction and storage temperature rang	e	T _J , T _{Stg}		- 55 to 175	°C	
Maximum thermal resistar junction to case	nce,	R _{thJC}	DC operation	2	°C/W	
Typical thermal resistance case to heatsink	9,	R _{thCS}	Mounting surface, smooth and greased	0.5	C/VV	
Approximate weight				2	g	
Approximate weight	Approximate weight			0.07	OZ.	
Mayortic or to your a				6 (5)	kgf · cm	
Mounting torque	maximum			12 (10)	(lbf \cdot in)	
Marking device			Case style TO-220AB	21TT100		



High Performance Vishay High Power Products Schottky Generation 5.0, 20 A

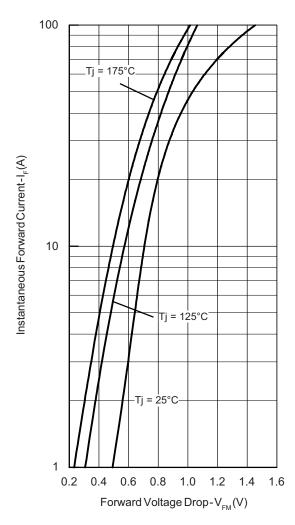


Fig. 1 - Maximum Forward Voltage Drop Characteristics

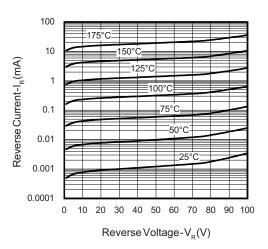


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

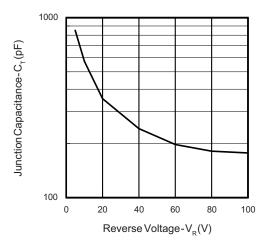


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

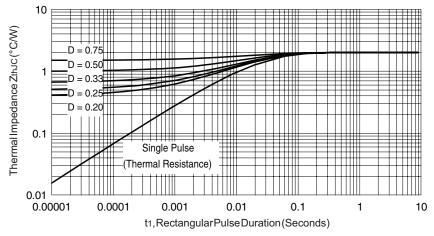


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

High Performance Schottky Generation 5.0, 20 A



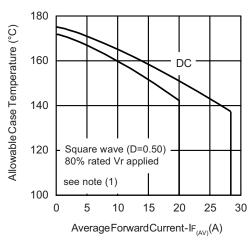


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

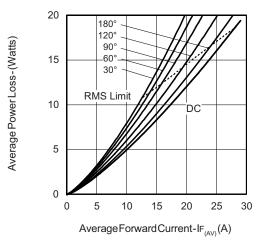


Fig. 6 - Forward Power Loss Characteristics

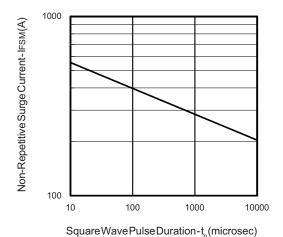
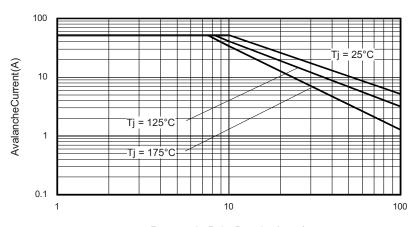


Fig. 7 - Maximum Non-Repetitive Surge Current

Note

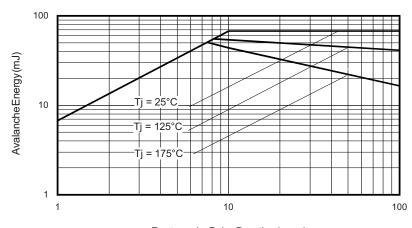


High Performance Vishay High Power Products Schottky Generation 5.0, 20 A



RectangularPulseDuration(µsec)

Fig. 8 - Reverse Bias Safe Operating Area (Avalanche Current vs. Rectangular Pulse Duration)



RectangularPulseDuration(µsec)

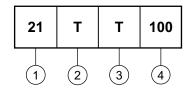
Fig. 9 - Reverse Bias Safe Operating Area (Avalanche Energy vs. Rectangular Pulse Duration)

High Performance Schottky Generation 5.0, 20 A



ORDERING INFORMATION TABLE

Device code



1 - Current rating (20 A)

2 - Package:

T = TO-220

3 - T = Trench

4 - Voltage code (100 V)

Tube standard pack quantity: 50 pieces

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95222				
Part marking information	http://www.vishay.com/doc?95225			



Vishay Semiconductors

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

- 1. Anode/open
- 2. Cathode
- 3. Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

CVMPOL	SYMBOL MILLIMETERS		INCHES		NOTES	
STIMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
E	10.11	10.51	0.398	0.414	3, 6	
E1	6.86	8.89	0.270	0.350	6	
E2	-	0.76	-	0.030	7	
е	2.41	2.67	0.095	0.105		
e1	4.88	5.28	0.192	0.208		
H1	6.09	6.48	0.240	0.255	6, 7	
L	13.52	14.02	0.532	0.552		
L1	3.32	3.82	0.131	0.150	2	
ØΡ	3.54	3.73	0.139	0.147		
Q	2.60	3.00	0.102	0.118		
θ	90° to 93°		90° t	o 93°		
		•	•	•		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

Lead tip



Legal Disclaimer Notice

Vishay

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